

RECC

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To the Honorable Commissioner of Patents

Send original documents or copy thereof.

1. Name of conveying party(ies): Material Sciences Development Corporation

2. Name and address of receiving party(ies)
Name: Material Sciences Corporation

Additional name(s) of conveying party(ies) attached? Yes No

Internal Address: _____

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Street Address: 2200 East Pratt Boulevard

Elk Grove Village, IL 60007-5995
City: _____ State: _____ ZIP: _____

Execution Date: June 30, 2000

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

08/873,929

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Joseph W. Berenato, III

Internal Address: _____

Street Address: Liniak, Berenato, Longacre & White, LLC
6550 Rock Spring Drive, Ste. 240

City: Bethesda, State: MD ZIP: 20817

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

50-0548

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Matthew W. Stavish

Name of Person Signing

Signature

6-30-00

Date

4

Total number of pages including cover sheet, attachments, and document:

ASSIGNMENT

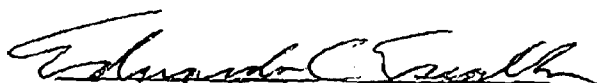
In consideration for One Dollar and other good and valuable consideration, receipt of which is hereby acknowledged, Terronics Development Corporation ("TDC"), of 7565 W. 900 N., Elwood, Indiana 46036, hereby sells, assigns, transfers and sets over to Material Sciences Corporation, having its principal place of business at 2200 East Pratt Boulevard, Elk Grove Village, Illinois 60007-5995, its successors, assigns, nominees, or other legal representatives, the entire right, title and interest in all countries including the priority rights derived from the hereinafter designated application for Letters Patent by virtue of the International Convention for the Protection of Industrial Property for any and all member countries of the aforesaid International Convention, in and to the invention or inventions made by us for a POWDER ATOMIZER and the application for Letters Patent of the United States therefor, executed by us on or about June 11, 1997, and bearing a filing date of June 12, 1997, and a Serial No. 08/873,929 together with all rights, including the sole rights under the aforesaid International Convention to apply for and obtain Letters Patent for said invention or inventions in the United States and in all other countries of the world, including original, divisional, continuation, continuation-in-part, reissue, utility and design patents, patents of addition, confirmation patents, registration patents, petty patents, utility models, etc., and all other types of patents and the like, and all renewals and extensions of any of them, and the entire right, title and interest in and to all such Letters Patent, the applications therefor and the subject matter of all claims obtained in said Letters Patent, and authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue Letters Patent on applications as aforesaid to issue the said Letters Patent to the Material Sciences Corporation., its successors, assigns, nominees or other legal representatives, as assignee of the

entire interest, and covenant that we convey the entire interest herein assigned and that we have not executed and will not execute any agreement in conflict herewith.

We further covenant and agree that whenever requested by said Material Sciences Corporation, its successors, assigns, nominees or legal representatives, we will execute and deliver or cause to be executed and delivered such further patent applications, assignments, oaths, disclaimers and other documents, give or cause to be given such evidence and furnish or cause to be furnished such information within our knowledge or control, and do or cause to be done such other acts and furnish or cause to be furnished such other assistance, as it or any of them may deem necessary or desirable in connection with obtaining and/or maintaining any Letters Patent as aforesaid for said invention or inventions, or in connection with any suit or controversy, including interference proceedings, relating to any of such Letters Patent or to any applications therefor or in order to vest or perfect in it or in any of them or to protect or enforce the right, title and interest herein assigned, or otherwise effectuate the premises, all without further consideration but at the expense of said Material Sciences Corporation, its successors, assigns, nominees or other legal representatives.

We hereby grant to Joseph W. Berenato, III of Liniak, Berenato, Longacre & White, LLC, full power to insert herein the execution and filing dates and serial number of the application for Letters Patent of the United States first above mentioned.

Date: June 30th, 2000


Eduardo C. Escallon
President of Terronics Development Corporation